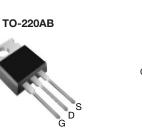
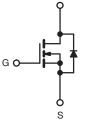


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Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	500				
R _{DS(on)} (Ω)	V _{GS} = 10 V 0.85				
Q _g (Max.) (nC)	38				
Q _{gs} (nC)	9.0				
Q _{gd} (nC)	18				
Configuration	Single				





N-Channel MOSFET

FEATURES

• Low Gate Charge Q_q Results in Simple Drive Requirement



- Improved Gate, Avalanche and Dynamic dV/dt RoHS COMPLIANT Ruggedness
- Fully Characterized Capacitance and Avalanche Voltage and Current
- Effective Coss Specified
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptable Power Supply
- High Speed Power Switching

TYPICAL SMPS TOPOLOGIES

- Two Transistor Forward
- Half Bridge
- Full Bridge

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRF840APbF			
Lead (Fb)-liee	SiHF840A-E3			
SnPb	IRF840A			
	SiHF840A			

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	500	v	
Gate-Source Voltage			V _{GS}	± 30	V	
Continuous Drain Current		T _C = 25 °C		8.0		
Continuous Drain Current	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	I _D	5.1	А	
Pulsed Drain Current ^a			I _{DM}	32		
Linear Derating Factor				1.0	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	510	mJ	
Repetitive Avalanche Current ^a			I _{AR}	8.0	А	
Repetitive Avalanche Energy ^a			E _{AR}	13	mJ	
Maximum Power Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$			PD	125	W	
Peak Diode Recovery dV/dt ^c			dV/dt	5.0	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150		
Soldering Recommendations (Peak Temperature)	for	10 s		300 ^d	°C	
Mounting Taxous	6-32 or M3 screw			10	lbf ∙ in	
Mounting Torque			Ī	1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = 50 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 16 mH, $R_g = 25 \Omega$, $I_{AS} = 8.0 \text{ A}$ (see fig. 12).

c. $I_{SD} \le 8.0$ A, dI/dt ≤ 100 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.	MAX.		UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-		62 - 1.0				
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50				°C/W		
Maximum Junction-to-Case (Drain)	R _{thJC}	-						
SPECIFICATIONS ($T_J = 25 \text{ °C}$, u	Inless otherw	ise noted)						
PARAMETER	SYMBOL	TEST	CONDITIC	ONS	MIN.	TYP.	MAX.	UNIT
Static	•							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0$) V, I _D = 25	i0 μA	500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I	_D = 1 mA	-	0.58	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V$	′ _{GS} , I _D = 25	50 µA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	V _G	_S = ± 30 V	1	-	-	± 100	nA
Zava Cata Valtaga Dusin Ourset	1	$V_{DS} = 500 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ $V_{DS} = 400 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		= 0 V	-	-	25	
Zero Gate Voltage Drain Current	IDSS			-	-	250	μA	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D	= 4.8 A ^b	-	-	0.85	Ω
Forward Transconductance	9 _{fs}	V _{DS} = 5	0 V, I _D = 4	.8 A ^b	3.7	-	-	S
Dynamic	•	•						
Input Capacitance	C _{iss}	l v	<u> Х</u> 0.У		-	1018	-	
Output Capacitance	C _{oss}	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5 $V_{GS} = 0 V; V_{DS} = 1.0 V, f = 1.0 MHz$		-	155	-	pF	
Reverse Transfer Capacitance	C _{rss}			-	8.0	-		
Output Capacitance	C _{oss}				1490			
Output Capacitance	C _{oss}	V _{GS} = 0 V; V _{DS} = 400 V, f = 1.0 MHz			42			
Effective Output Capacitance	C _{oss} eff.	V_{GS} = 0 V; V_{DS} = 0 V to 400 V ^c			56			
Total Gate Charge	Qg				-	-	38	nC
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V		, V _{DS} = 400 V, g. 6 and 13 ^b	-	-	9.0	
Gate-Drain Charge	Q _{gd}		300 1	g. o and to	-	-	18	
Turn-On Delay Time	t _{d(on)}				-	11	-	
Rise Time	t _r	- V _{DD} = 2	V_{DD} = 250 V, I_D = 8 A R_g = 9.1 Ω,R_D = 31 $\Omega,$ see fig. 10^b		-	23	-	- ns
Turn-Off Delay Time	t _{d(off)}	R _g = 9.1 Ω, R			-	26	-	
Fall Time	t _f	1		-	19	-	1	
Drain-Source Body Diode Characteristic	cs							•
Continuous Source-Drain Diode Current	١ _S	MOSFET symbol showing the integral reverse p - n junction diode		_	-	8.0	Α	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	32	~	
Body Diode Voltage	V _{SD}	T _J = 25 °C,	$T_J = 25 \ ^{\circ}C, \ I_S = 8 \ A, \ V_{GS} = 0 \ V^b$		-	-	2.0	V
Body Diode Reverse Recovery Time	t _{rr}	T = 05 %0 L	.0 ۸ مار <u>ا</u>	- 100 A/	-	422	633	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = 8 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}^{b}$		-	2.16	3.24	μC	
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn			n-on is dou	minated h	vland	15)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

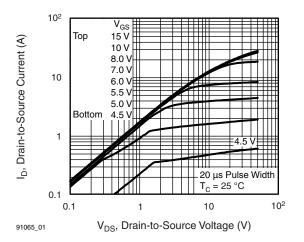
b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

c. C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 1 - Typical Output Characteristics, T_C = 25 °C

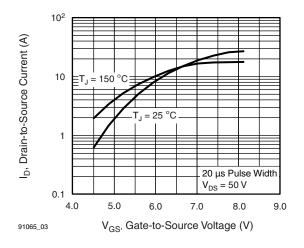


Fig. 3 - Typical Transfer Characteristics

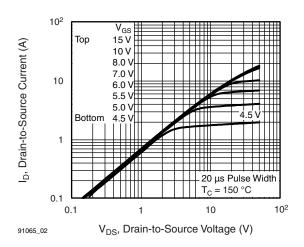


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

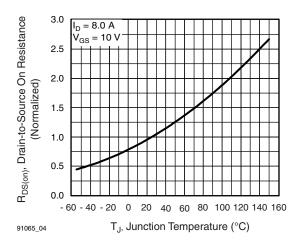


Fig. 4 - Normalized On-Resistance vs. Temperature

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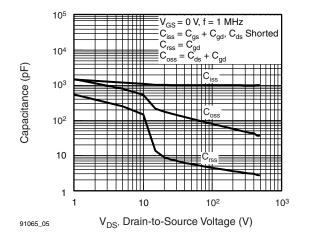


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

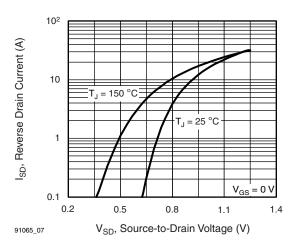


Fig. 7 - Typical Source-Drain Diode Forward Voltage

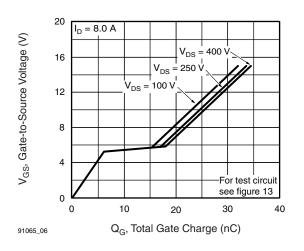


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

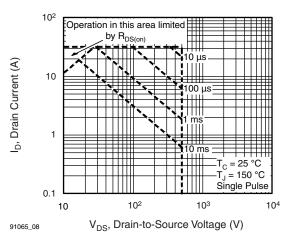


Fig. 8 - Maximum Safe Operating Area

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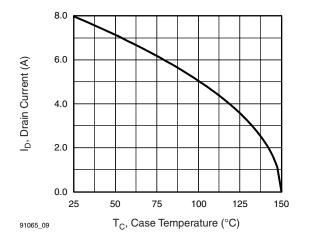


Fig. 9 - Maximum Drain Current vs. Case Temperature

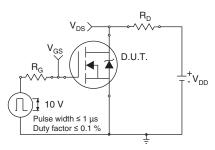


Fig. 10a - Switching Time Test Circuit

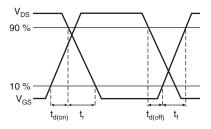


Fig. 10b - Switching Time Waveforms

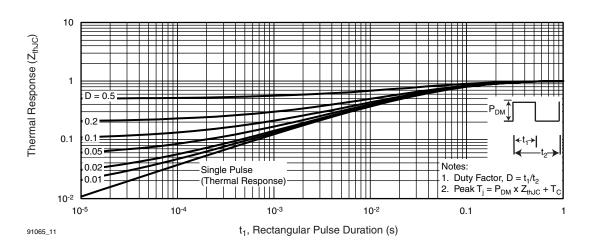


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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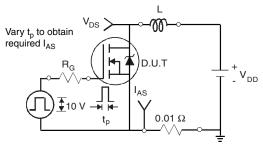


Fig. 12a - Unclamped Inductive Test Circuit

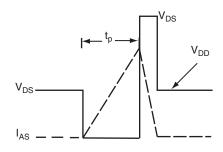


Fig. 12b - Unclamped Inductive Waveforms

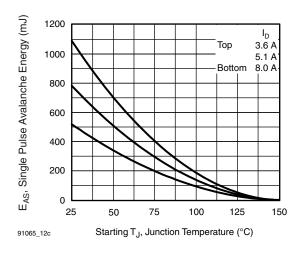


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

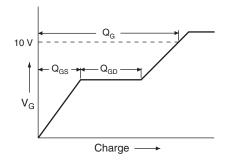


Fig. 12d - Basic Gate Charge Waveform

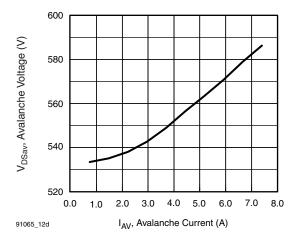


Fig. 13a - Typical Drain-to-Source Voltage vs. Avalanche Current

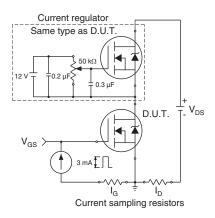


Fig. 13b - Gate Charge Test Circuit

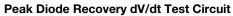
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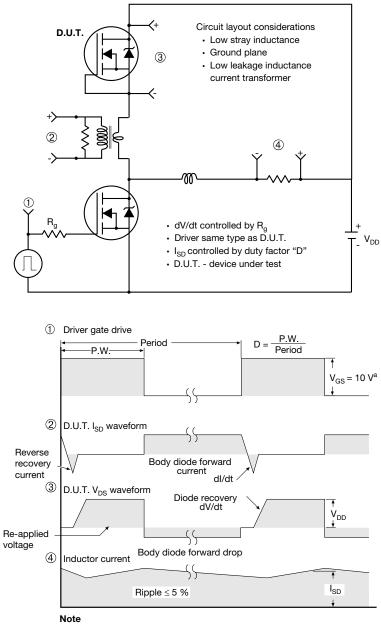
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a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture						
ASE		Xi'an				
		IRF 9510 744K AB				

Revison: 14-Dec-15

1 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 66542

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